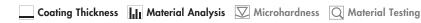
FISCHERSCOPE® X-RAY XDLM®-PCB 200 FISCHERSCOPE® X-RAY XDLM®-PCB 210 FISCHERSCOPE® X-RAY XDLM®-PCB 220

Specific X-Ray Fluorescence Measuring Instruments for Measurements and Analyses of Coating Thicknesses and Compositions on Printed Circuit Boards







FISCHERSCOPE® X-RAY XDLM®-PCB

Description

The FISCHERSCOPE X-RAY XDLM-PCB instruments are specific robust entry-level instruments for measurements and analyses of coating thicknesses and compositions on printed circuit boards.

Typical fields of application:

- Measurements on small components and structures on printed circuit boards in sizes up to 610 x 610 mm (24 x 24 in)
- Measurements of functional coatings in the electronics and semiconductor industries
- XDLM-PCB 210 and 220: Automated measurements, e.g., in quality control
- Determining the composition of electroplating baths

A high count rate is achieved by using a micro-focus X-ray source and a proportional counter tube, which allows for precise measurements. Outstanding accuracy and long-term stability are characteristics of all FISCHERSCOPE X-RAY systems. The necessity of recalibration is dramatically reduced, saving time and effort.

The fundamental parameter method by FISCHER allows for the analysis of solid and liquid specimens as well as coating systems without calibration.

For measurements on large printed circuit boards and multi-panels, the XDLM-PCB 200 can be equipped with a sample stage extension to enlarge the usable sample placement area.

The XDLM-PCB 220 features electrically changeable apertures and primary filters to create ideal excitation conditions for every measurement. This makes the instrument extremely versatile.

Design

The FISCHERSCOPE X-RAY XDLM-PCB Series is designed as a user-friendly bench-top instrument. The housing features a slot in the side allowing for the measurement of large pc-boards.

Both instruments feature an easy sample positioning:

- XDLM-PCB 200: The PCB will be roughly positioned with the help of the integrated laser pointer. Then the sample support will be pushed into the instrument similar to a drawer.
- XDLM-PCB 210 and 220: The instrument is equipped with a high-precision, programmable XY-stage with a pop out function. A laser pointer serves as a positioning aid and supports the quick alignment of the sample to be measured.

A high-resolution color video camera simplifies the precise determination of the measurement spot.

The entire operation and evaluation of measurements as well as the clear presentation of measurement data is performed on a PC, using the powerful and user-friendly WinFTM $^{\circledR}$ software.

The X-RAY XDLM-PCB Series fulfills DIN ISO 3497 and ASTM B 568.

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General	Spec	itica:	tion

g instrument (EDXRF) to determine thin
ements simultaneously
side

X-Ray Source

X-Kay Source	
X-ray tube	Micro-focus tungsten tube with beryllium window
High voltage	Three steps: 30 kV, 40 kV, 50 kV
Apertures (Collimators)	 XDLM-PCB 200/210: Ø 0.1 mm (3.9 mils), optional Ø 0.2 mm (7.9 mils), slot 0.3 x 0.05 mm (11.8 x 2 mils)
	• XDLM-PCB 220:
	Standard (523-440): Ø 0.1 mm (3.9 mils); Ø 0.2 mm (7.9 mils); 0.05 x 0,05 mm
	$(2 \times 2 \text{ mils})$; 0.2 × 0.03 mm (7.9 × 1.2 mils)
	Optional (523-366): \varnothing 0.1 mm (3.9 mils); \varnothing 0.2 mm (7.9 mils); \varnothing 0.3 mm (11.8 mils); 0.3 x 0.05 mm (11.8 x 2 mils)
Primary filter	• XDLM-PCB 200/210: fixed
	 XDLM-PCB 220: 3x changeable: (Standard: Nickel, Aluminum, free)
Measurement spot	Depending on the measuring distance and on the aperture, the actual measurement

spot size is shown in the video image.

Smallest measurement spot: approx. Ø 0.2 mm (7.9 mils)

Measuring distance

0 ... 10 mm (0 ... 0.4 in)

Distance compensation with patented DCM method for simplified measurements at varying distances. For particular applications or for higher demands on accuracy an additional calibration might be necessary.

X-Ray Detection

X-ray detector	Proportional counter tube
Video Microscope	
	High-resolution CCD color camera for optical monitoring of the measurement loca-

tion along the primary beam axis, Manual focusing and auto-focus, Crosshairs with a calibrated scale (ruler) and spot-indicator, Adjustable LED illumination, Laser pointer (class 1) to support accurate specimen placement

Zoom factor Digital: 1x, 2x, 3x, 4x

Dimensions	XDLM-PCB 200	XDLM-PCB 210	
External dimensions	610 x 750 x 450 mm	With maximum XY travel range:	
Width x depth x height	(24 x 29.5 x 17.7 in) 1000 x 1265 x 470 (39.4 x 49.8 x 18.5		
	With extension:	XY table retracted in home position	
	1200 x 1050 x 450 mm	650 x 810 x 470 mm	
	$(47.2 \times 41.3 \times 17.7 \text{ in})$	(25.6 x 31.9 x 18.5 in)	
Weight	Approx. 86 kg (190 lb)		

FISCHERSCOPE® X-RAY XDLM®-PCB

XDLM-PCB 210/220

XDLM-PCB 200

	Fixed sample suppo		-	XY-stage with pop out
Usable sample placement area Width x depth	600 x 600 mm (With ext	23.6 x 23.6 in) ension:		nm (23.6 x 23.6 in)
Maximum travel XY-axis	1200 X 700 IIIII	(47.2 X 33.4 III)	450 x 300 m	nm (17.7 x 11.8 in)
Max. travel speed XY				/s (2.4 in/s)
Repeatability precision XY				1 mils), unidirectional
Max. sample weight	5 ka (11 lb)	·	g (11 lb)
Max. sample height	5 kg (11 lb) 5 kg (11 lb) 5 mm			
Electrical data				
Power supply	AC 115 V or AC 230	0 V 50 / 60 Hz		
Power consumption	Max. 120 W			
Protection class	IP40			
Environmental Conditions				
Operating temperature	10 °C – 40 °C / 50 °F – 104 °F			
Storage/Transport temperature	0 °C – 50 °C / 32 °F – 122 °F			
Admissible air humidity	≤ 95 %, non-condensing			
Evaluation unit				
Computer	Windows [®] -PC			
Software	Standard: Fischer WinFTM [®] BASIC Optional: Fischer WinFTM [®] PDM [®] , SUPER			
Standards				
CE approval	EN 61010			
X-Ray standards	DIN ISO 3497 and ASTM B 568			
Approval	Individual acceptance inspection as a fully protected instrument according to the German regulations "Deutsche Röntgenverordnung-RöV".			
Order				
FISCHERSCOPE X-RAY XDLM-PCB 200	605-011	Measuring cell for so	olution analysis	605-032
FISCHERSCOPE X-RAY XDLM-PCB 210	605-012	Sample stage extens XDLM-PCB 200	ion for	605-033
FISCHERSCOPE X-RAY XDLM-PCB 220	605-110			
Special XDLM-PCB product modification		al consultation on roa	uest	

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Sample Stage

